

DSA300I45NA

preliminary

 $V_{RRM} = 45 V$

 $I_{FAV} = 300 A$

 $V_F = 0.76 V$

High Performance Schottky Diode Low Loss and Soft Recovery Single Diode

Schottky Diode Gen²

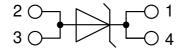
Part number

DSA300I45NA



Backside: Isolated





Features / Advantages:

- Very low Vf
- Extremely low switching losses
- Low Irm values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

Package: SOT-227B (minibloc)

- Isolation Voltage: 3000 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Base plate: Copper internally DCB isolated
- Advanced power cycling

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preliminary

Schottky					Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit	
V _{RSM}	max. non-repetitive reverse blocki	ng voltage	$T_{VJ} = 25^{\circ}C$			45	V	
V _{RRM}	max. repetitive reverse blocking voltage		$T_{VJ} = 25^{\circ}C$			45	V	
IR	reverse current, drain current	$V_R = 45 V$	$T_{VJ} = 25^{\circ}C$			3	mA	
		$V_R = 45 \text{ V}$	$T_{VJ} = 150$ °C			30	mΑ	
V _F	forward voltage drop	I _F = 300 A	$T_{VJ} = 25^{\circ}C$			0.84	V	
		$I_F = 600 A$				1.14	٧	
		I _F = 300 A	T _{vJ} = 125°C			0.76	V	
		$I_F = 600 A$				1.10	٧	
I _{FAV}	average forward current	T _c = 100°C	T _{vJ} = 150°C			300	Α	
		rectangular $d = 0.5$					i I I I	
V _{F0}	threshold voltage		T _{vJ} = 150°C			0.41	V	
r _F	slope resistance } for power lo	ss calculation only				1.12	mΩ	
R _{thJC}	thermal resistance junction to case	9				0.15	K/W	
R _{thCH}	thermal resistance case to heatsin	k			0.1		K/W	
P _{tot}	total power dissipation		$T_{C} = 25^{\circ}C$			830	W	
I _{FSM}	max. forward surge current	$t = 10 \text{ ms}$; (50 Hz), sine; $V_R = 0 \text{ V}$	$T_{VJ} = 45^{\circ}C$			4.80	kA	
C	junction capacitance	$V_R = 5V f = 1 MHz$	$T_{VJ} = 25^{\circ}C$		16.5		nF	

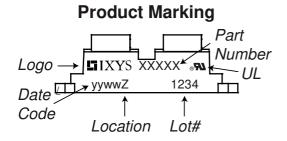


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Package	ge SOT-227B (minibloc)			Ratings				
Symbol	Definition	Conditions			min.	typ.	max.	Unit
I _{RMS}	RMS current	per terminal 1)					150	Α
T _{VJ}	virtual junction temperature	9			-40		150	°C
Top	operation temperature				-40		125	°C
T _{stg}	storage temperature				-40		150	°C
Weight						30		g
M _D	mounting torque				1.1		1.5	Nm
$\mathbf{M}_{_{T}}$	terminal torque				1.1		1.5	Nm
d _{Spp/App}	creepage distance on surface striking distance through air		terminal to terminal	10.5	3.2			mm
$d_{Spb/Apb}$			terminal to backside	8.6	6.8			mm
V _{ISOL}	isolation voltage	t = 1 second	50/00 II - 51/0 I / - 1					٧
		t = 1 minute	50/60 Hz, RMS; I _{ISOL} ≤ 1 mA		2500			٧

¹⁾ I_{hus} is typically limited by the pin-to-chip resistance (1); or by the current capability of the chip (2). In case of (1) and a product with multiple pins for one chip-potential, the current capability can be increased by connecting the pins as one contact.



Part description

D = Diode S = Schottky Diode

A = low VF

300 = Current Rating [A]

I = Single Diode

45 = Reverse Voltage [V] NA = SOT-227B (minibloc)

Ordering **Ordering Number Marking on Product Delivery Mode** Quantity Code No. Standard DSA300I45NA DSA300I45NA 10 511251 Tube

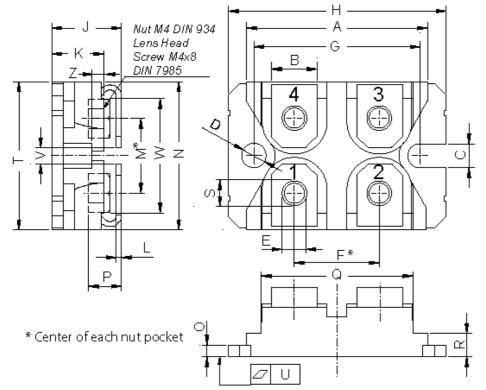
Similar Part	Package	Voltage class
DSA300I100NA	SOT-227B (minibloc)	100
DSA300I200NA	SOT-227B (minibloc)	200

Equivalent Circuits for Simulation			* on die level	$T_{VJ} = 150^{\circ}C$
$I \rightarrow V_0$)—[R _o]–	Schottky		
V _{0 max}	threshold voltage	0.41		V
$R_{0 max}$	slope resistance *	0.28		mΩ

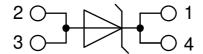


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Outlines SOT-227B (minibloc)



Dim.	Millimeter		Inches		
Dilli.	min	max	min	max	
Α	31.50	31.88	1.240	1.255	
В	7.80	8.20	0.307	0.323	
С	4.09	4.29	0.161	0.169	
D	4.09	4.29	0.161	0.169	
Е	4.09	4.29	0.161	0.169	
F	14.91	15.11	0.587	0.595	
G	30.12	30.30	1.186	1.193	
Н	37.80	38.23	1.488	1.505	
J	11.68	12.22	0.460	0.481	
K	8.92	9.60	0.351	0.378	
L	0.74	0.84	0.029	0.033	
M	12.50	13.10	0.492	0.516	
N	25.15	25.42	0.990	1.001	
0	1.95	2.13	0.077	0.084	
Р	4.95	6.20	0.195	0.244	
Q	26.54	26.90	1.045	1.059	
R	3.94	4.42	0.155	0.167	
S	4.55	4.85	0.179	0.191	
Т	24.59	25.25	0.968	0.994	
U	-0.05	0.10	-0.002	0.004	
V	3.20	5.50	0.126	0.217	
W	19.81	21.08	0.780	0.830	
Z	2.50	2.70	0.098	0.106	





Schottky

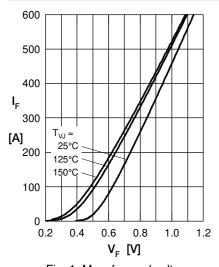
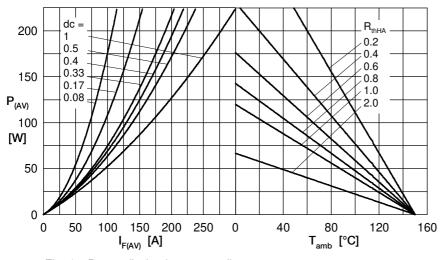
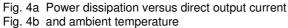


Fig. 1 Max. forward voltage drop characteristics

Fig. 2 Typ. reverse current I_R vs. reverse voltage V_R

Fig. 3 Typ. junction capacitance C_T vs. reverse voltage V_R





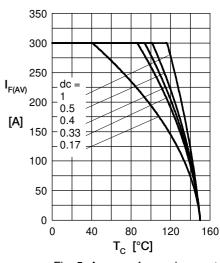


Fig. 5 Average forward current $I_{F(AV)}$ vs. case temp. T_{C}

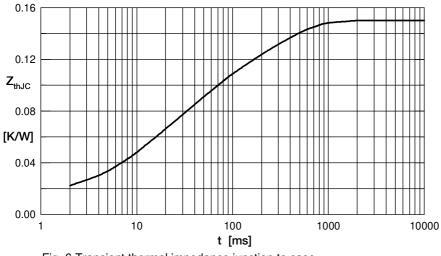


Fig. 6 Transient thermal impedance junction to case

R _{thi} [K/W]	t _i [s]
0.017	0.01
0.013	0.00001
0.02	0.01
0.05	0.045
0.05	0.3